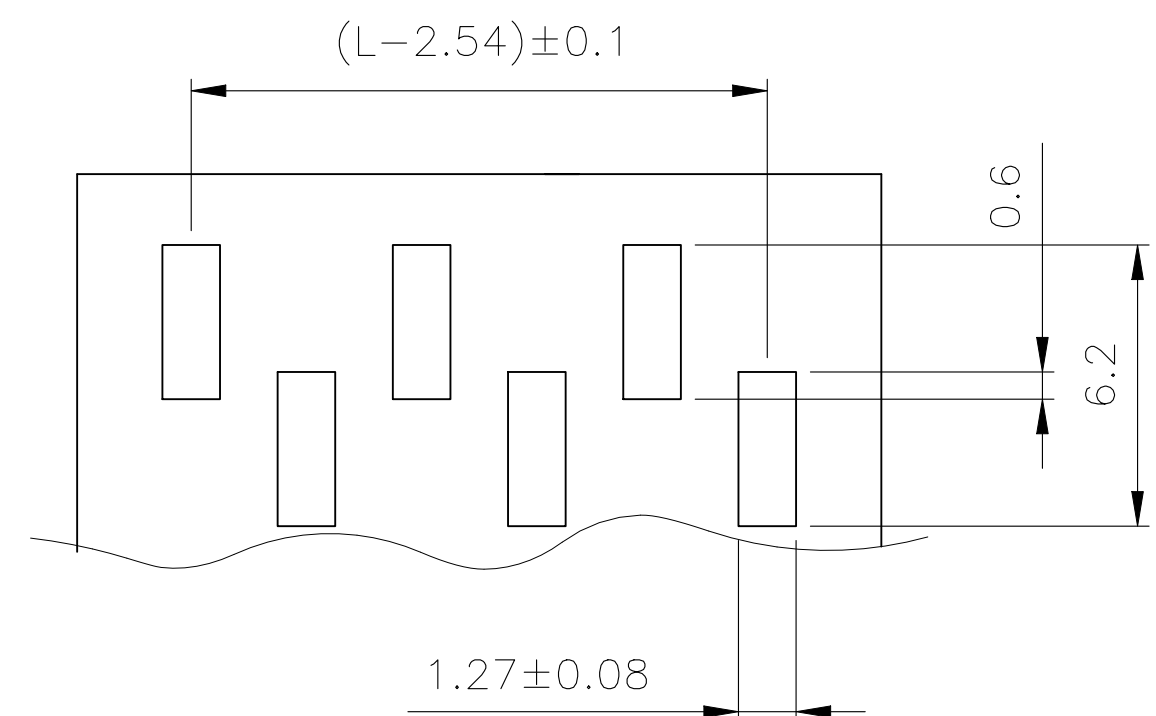
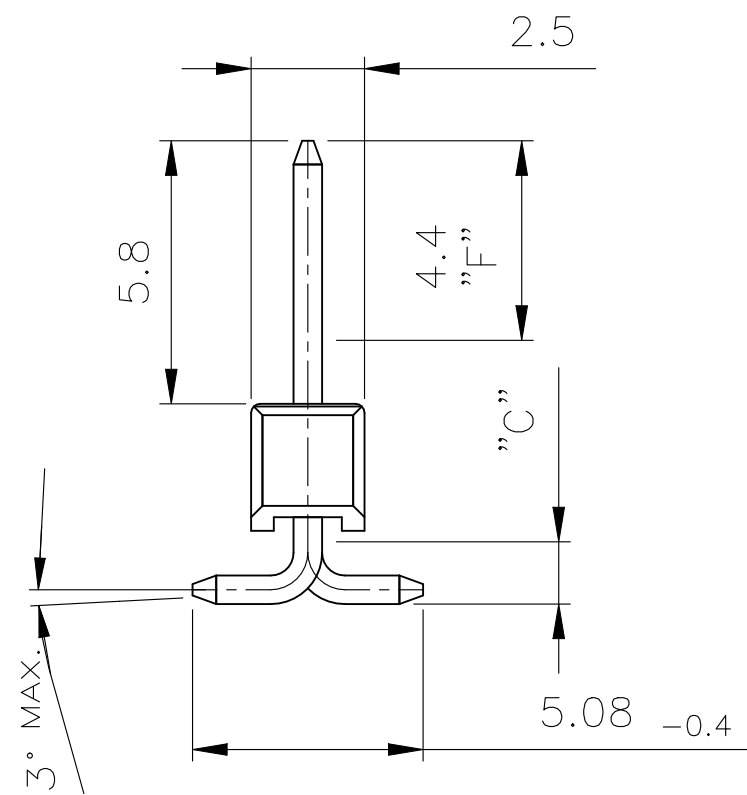
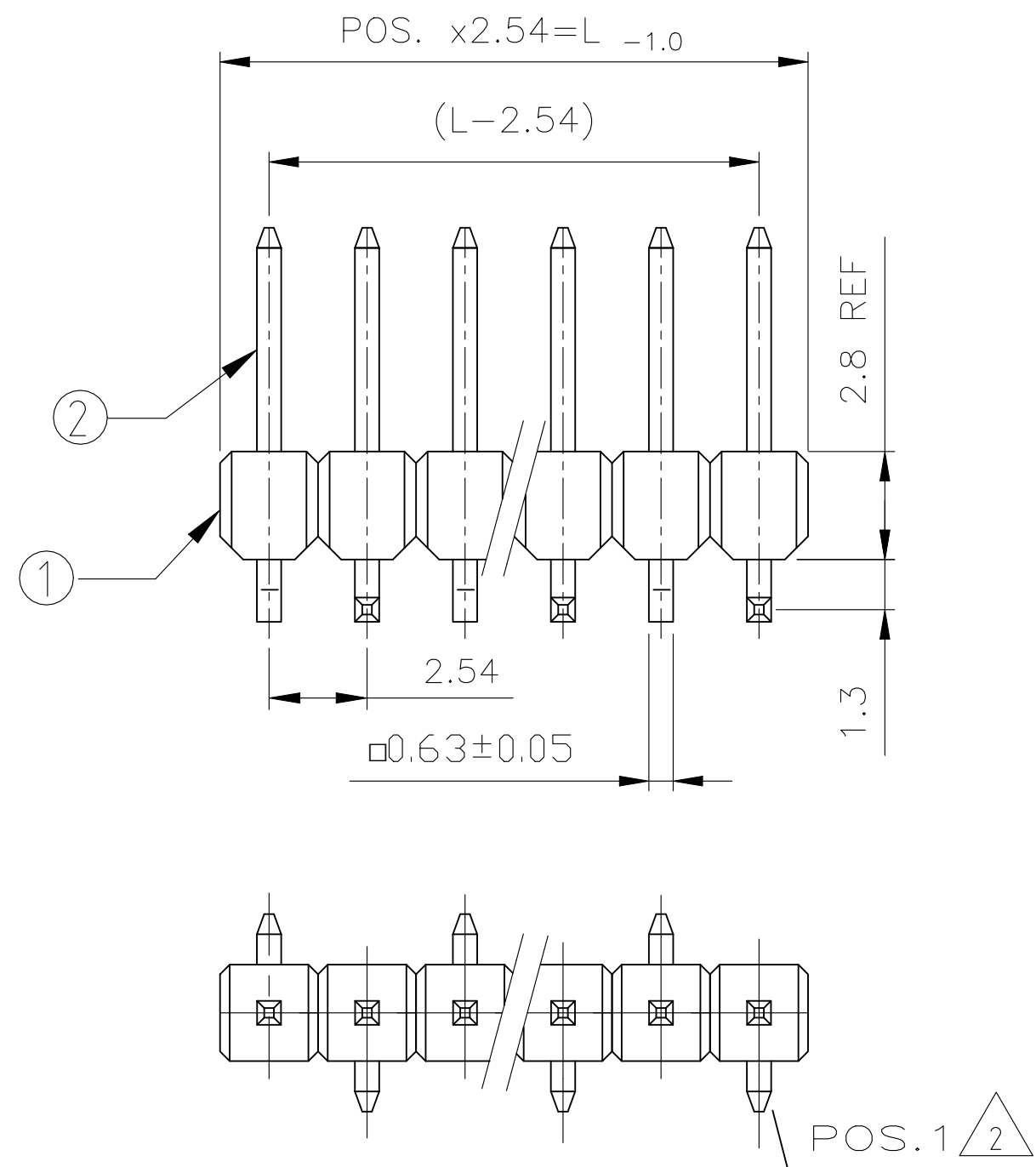


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Pos.	$L_{-0.9}$
—	-
3	7.62
4	10.16
5	12.7
6	15.24
7	17.78
8	20.32
9	22.86
10	25.4
11	27.94
12	30.48
13	33.02
14	35.56
15	38.1
16	40.64
17	43.18


REVISIONS ÄNDERUNGEN						
P	LTR	DESCRIPTION BESCHREIBUNG	DATE	DWN	APVD	
	D1	NOTE 1 0.76µm PLATING UPDATE (PdNi+AuFLASH)	13JUL2023	BGC	PS	





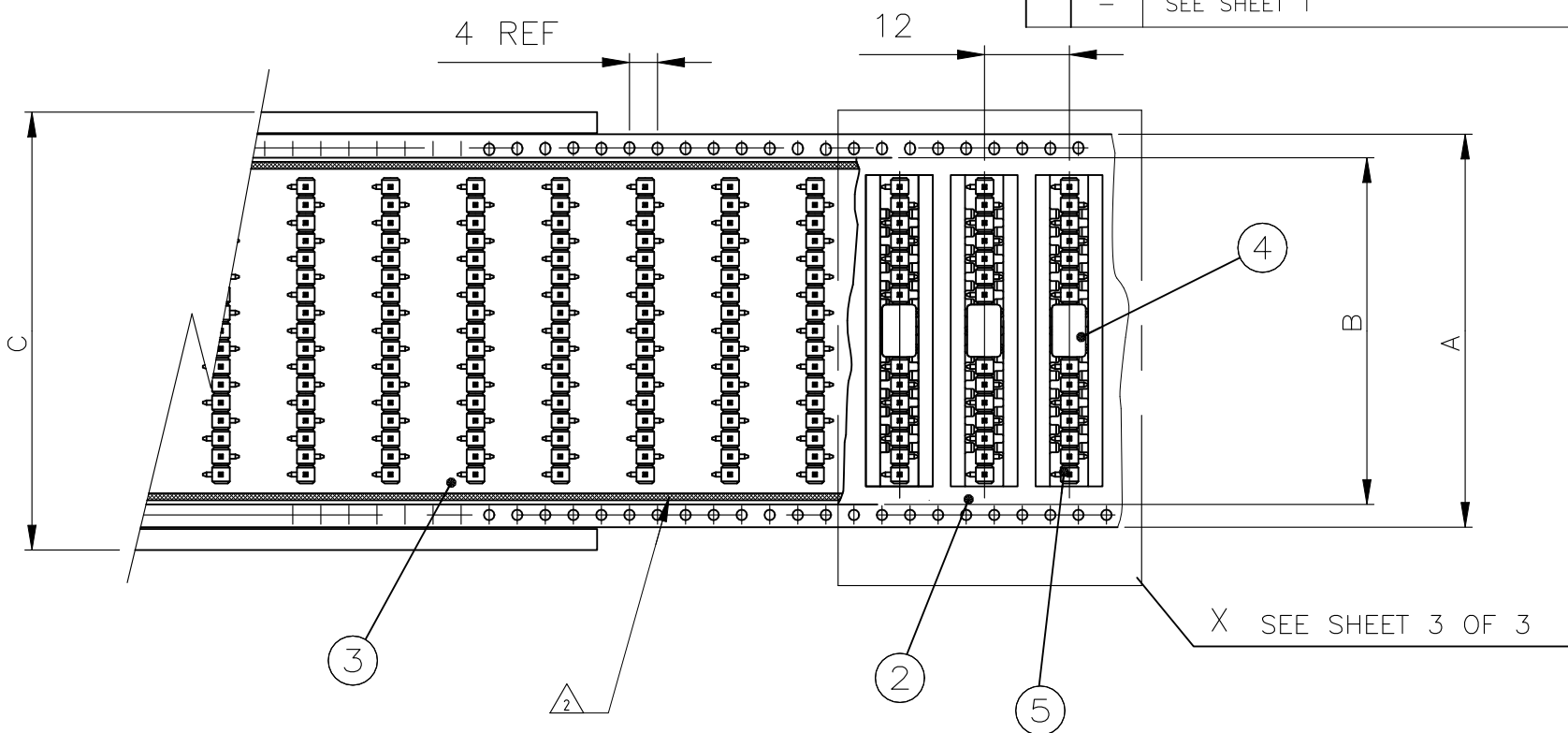
RECOMMENDED PCB-LAYOUT

1 MATING SIDE: Min 0.76μm (PdNi + Au FLASH)IN ZONE "F" OVER Min 1.27μm Ni
(Alternative plating – Min 0.76μm Au OVER Min 1.27μm Ni)
SOLDER SIDE: 3.0 TO 5.0 μm TIN OVER 1.27μm NICKEL























































































 PAY ATTENTION THE POSITION 1 CONTACT.



KONTAKTSTIFT / CONTACT PIN	CuZn		2
STIFTGEHÄUSE / PIN HOUSING	PCT	SCHWARZ / BLACK	1
BENENNUNG EINZELTEIL PART DESCRIPTION	WERKSTOFF MATERIAL	OBERFLÄCHE / FARBE SURFACE / COLOR	SI No

THIS DRAWING IS A CONTROLLED DOCUMENT. DIESE ZEICHNUNG IST EIN KONTROLLIERTES DOKUMENT.		DWN T.BERGER 29SEP1998		<div></div> TE Connectivity Ltd.							
DIMENSIONS: MASSENHEITEN: mm		CHK M.SCHAARSCHMIDT 29SEP1998						NAME			
TOLERANCES UNLESS OTHERWISE SPECIFIED: ALLGEMEINTOLERANZEN ± 0.1		APVD G.FELDMER									
		<div>PRODUCT SPEC PRODUKTSPEZ. 108-18012</div>		AMPMODU II PIN HEADER, SINGLE ROW, SMD, PACKED IN BLISTER							
MATERIAL SEE TABLE SIEHE TABELLE		FINISH/OBERFLÄCHE/FARBE SEE TABLE SIEHE TABELLE		SIZE A2		GAGE CODE 00779		DRAWING NO ZEICHNUNGS-NR. G-1241150		RESTRICTED TO NUR FÜR —	
CUSTOMER DRAWING / KUNDENZEICHNUNG						SCALE MASSTAB 1:5		SHEET BLATT 1 von 3		REV D1	



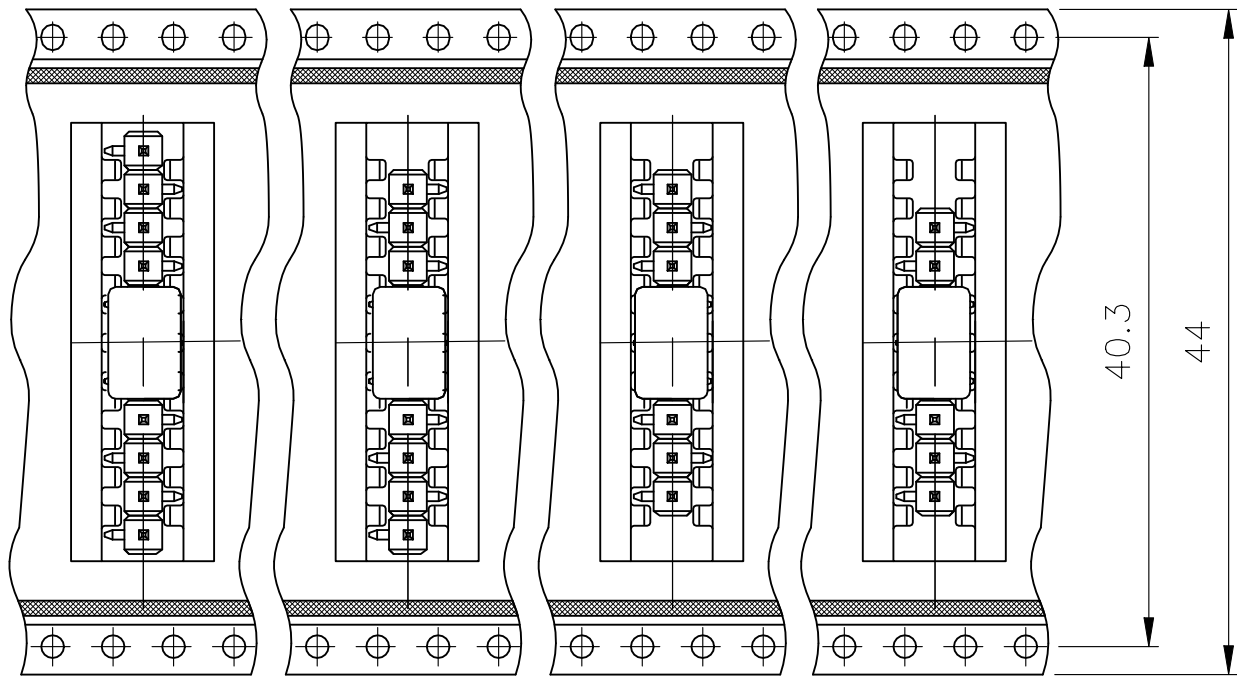
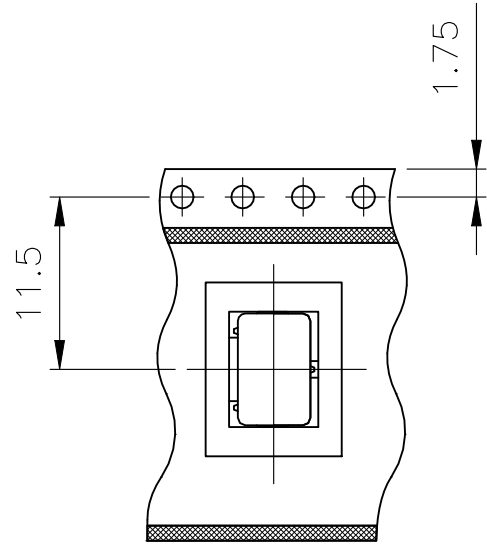
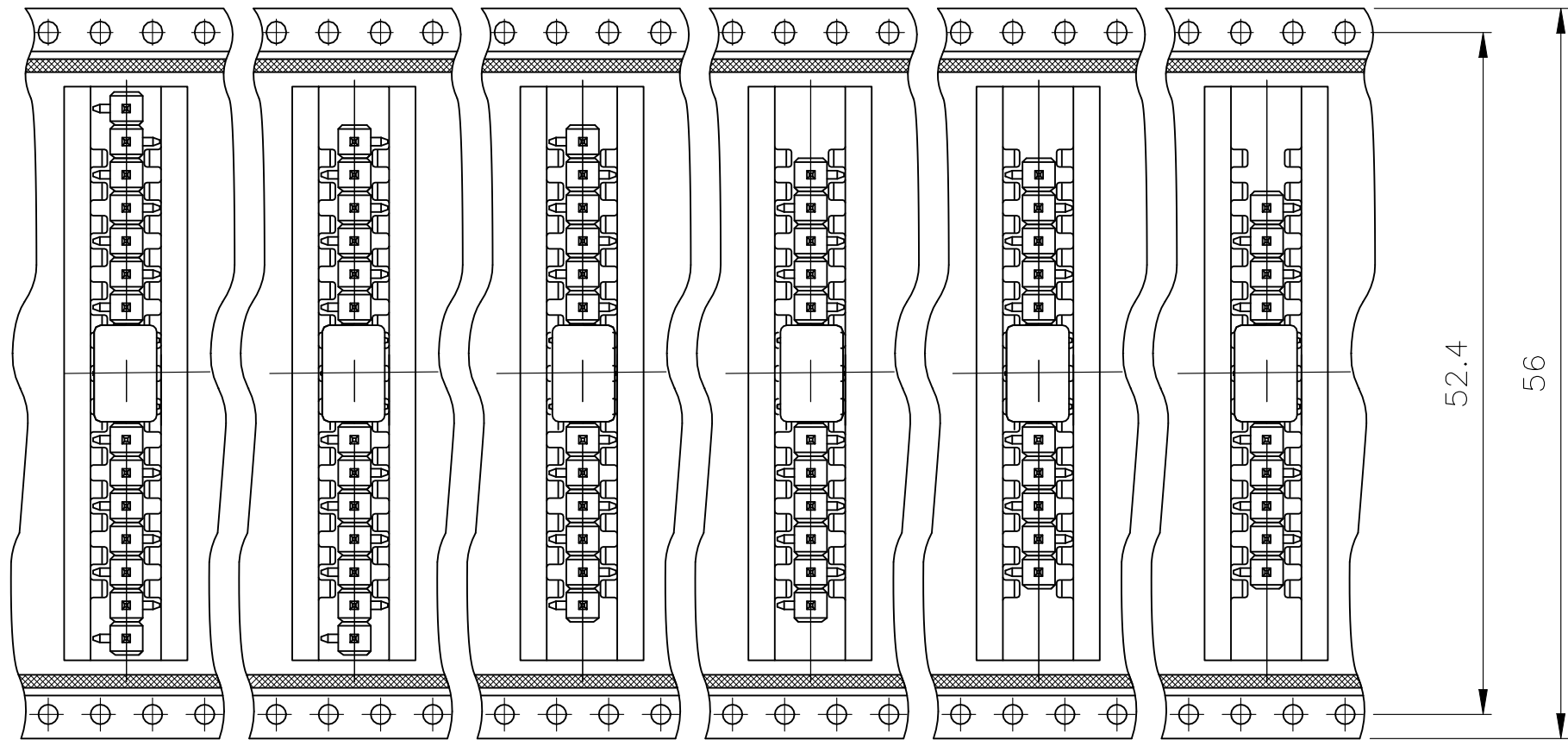
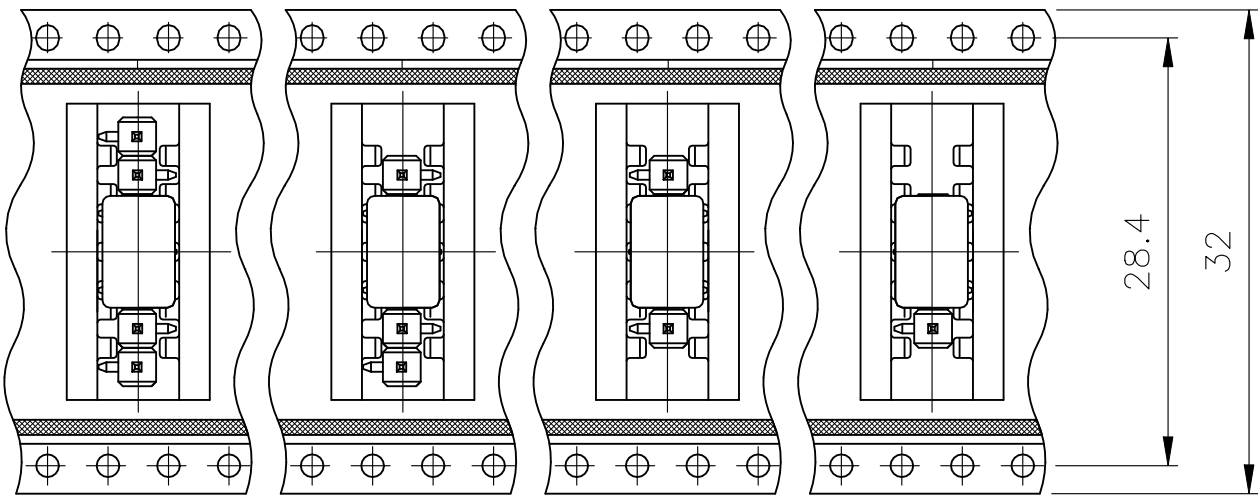
- ① SIEHE BLATT 1 VON 3
- ② VERPACKUNG: 500 STIFTLISTEN MIT ADAPTER PRO SPULE
6.6m BLISTER PRO SPULE
6.6m ABDECKFOLIE PRO SPULE
- ③ ABWICKELRICHTUNG
- ④ ABDECKFOLIE MIT BLISTERGURT VERSCHWEIßT
5. VERPACKUNG ENTSPRECHEND DIN/IEC 286 BZW. EIA 481
INKLUSIVE ANGABEN ÜBER DEN VOR- UND NACHLAUF
(DIN/IEC 286 TEIL 3)
6. ANORDNUNG DER STIFTLISTEN IM BLISTERGURT SIEHE BLATT 2 VON 3
- ⑦ VERPACKUNG: 400 STIFTLISTEN MIT ADAPTER PRO SPULE
5.4m BLISTER PRO SPULE
5.4m ABDECKFOLIE PRO SPULE
- ⑧ VERALTETE

1																5	AMPMODU II PIN HEADER,SMD, 17pos AMPMODU II STIFTLISTE,SMD, 17pol.			
	1															5	AMPMODU II PIN HEADER,SMD, 16pos AMPMODU II STIFTLISTE,SMD, 16pol.			
		1														5	AMPMODU II PIN HEADER,SMD, 15pos AMPMODU II STIFTLISTE,SMD, 15pol.			
			1													5	AMPMODU II PIN HEADER,SMD, 14pos AMPMODU II STIFTLISTE,SMD, 14pol.			
				1												5	AMPMODU II PIN HEADER,SMD, 13pos AMPMODU II STIFTLISTE,SMD, 13pol.			
					1											5	AMPMODU II PIN HEADER,SMD, 12pos AMPMODU II STIFTLISTE,SMD, 12pol.			
						1										5	AMPMODU II PIN HEADER,SMD, 11pos AMPMODU II STIFTLISTE,SMD, 11pol.			
							1									5	AMPMODU II PIN HEADER,SMD, 10pos AMPMODU II STIFTLISTE,SMD, 10pol.			
								1								5	AMPMODU II PIN HEADER,SMD, 9pos AMPMODU II STIFTLISTE,SMD, 9pol.			
									1							5	AMPMODU II PIN HEADER,SMD, 8pos AMPMODU II STIFTLISTE,SMD, 8pol.			
										1						5	AMPMODU II PIN HEADER,SMD, 7pos AMPMODU II STIFTLISTE,SMD, 7pol.			
											1					5	AMPMODU II PIN HEADER,SMD, 6pos AMPMODU II STIFTLISTE,SMD, 6pol.			
												1				5	AMPMODU II PIN HEADER,SMD, 5pos AMPMODU II STIFTLISTE,SMD, 5pol.			
													1			5	AMPMODU II PIN HEADER,SMD, 4pos AMPMODU II STIFTLISTE,SMD, 4pol.			
														1		5	AMPMODU II PIN HEADER,SMD, 3pos AMPMODU II STIFTLISTE,SMD, 3pol.			
1	1	1	1	1	1	1	1	1	1	1	1	1	1	1		4	ADAPTER		LCP	BLACK / SCHWARZ
																	3	COVER TAPE / ABDECKFOLIE B=49.4	PET	TRANSPARENT
																	3	COVER TAPE / ABDECKFOLIE B=37.4	PET	TRANSPARENT
																	3	COVER TAPE / ABDECKFOLIE B=25.4	PET	TRANSPARENT
																2	BLISTER BELT / BLISTERGURT A=56.0		PS	BLACK/SCHWARZ
																2	BLISTER BELT / BLISTERGURT A=44.0		PS	BLACK/SCHWARZ
																2	BLISTER BELT / BLISTERGURT A=32.0		PS	BLACK/SCHWARZ
																2	BLISTER BELT / BLISTERGURT A=16.0			
																1	REEL C=62.4		PS	GREY / GRAU
																1	REEL C=50.4		PS	GREY / GRAU
																1	REEL C=38.4		PS	GREY / GRAU
																1	REEL C=22.4			
1--7	1--6	1--5	1--4	1--3	1--2	1--1	1--0	-9	-8	-7	-6	-5	-4	-3	POS.		DESCRIPTION / BENENNUNG		MATERIAL	SURFACE/COLOUR

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DIESE ZEICHNUNG IST EIN KONTROLLIERTES DOKUMENT.		CHK. M. SCHLAARSCMIDT 29SEP1998			
DIMENSIONS: MASSENHEITEN: mm 		TOLERANCES UNLESS OTHERWISE SPECIFIED: ALLGEMEINTOLERANZEN 0 PLC ± 0.2 1 PLC ± 0.1 2 PLC ± 0.1 3 PLC ± 4 PLC ± ANGLES / WINKEL ± °		NAME AMPMODU II PIN HEADER, SINGLE ROW, SMD, PACKED IN BLISTER	
MATERIAL SEE TABLE SIEHE TABELLE		APVD G. FELDMEIER PRODUCT SPEC PRODUKTSPEZ. 108-18012 APPLICATION SPEC VERABEITUNGSSPEZ. — WEIGHT GEWICHT —		SIZE A2 CAGE CODE 00779 DRAWING NO. ZEICHNUNGS-NR. C-1241150 RESTRICTED TO NUR FÜR —	SCALE 1:2 SHEET 1 of 3 REV D1
FINISH / OBERFLÄCHE / FARBE SEE TABLE SIEHE TABELLE		CUSTOMER DRAWING / KUNDENZEICHNUNG			

A

REVISIONS					
ÄNDERUNGEN					
P	LTR	DESCRIPTION	DATE	DWN	APVD
		BESCHREIBUNG			
-	-	SEE SHEET 1	-	-	-



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DIMENSIONS:
MASSENHEITEN
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TOLERANCES, UNLESS
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1 PLC ± 0.1

2 PLC ± 0.1

3 PLC ± -

4 PLC ± -

ANGLES / WINKEL ± -

FINISH / OBERFLÄCHE / FARBE

-

DWN
T.BERGNER
29SEP1998

CHK
M.SCHAARSCHMIDT
29SEP1998

APVD
G.FELDMEIER
-

PRODUCT SPEC
PRODUKTSPEZ
108-18012

APPLICATION SPEC
VERARBEITUNGSSPEZ.
-

WEIGHT
GEWICHT
-

CUSTOMER DRAWING / KUNDENZEICHNUNG

SCALE
MASSTAB 1:1

TE Connectivity Ltd.

AMPMODU II PIN HEADER, SINGLE ROW,
SMD, PACKED IN BLISTER

SIZE
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ZEICHNUNGS-NR.
C-1241150

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